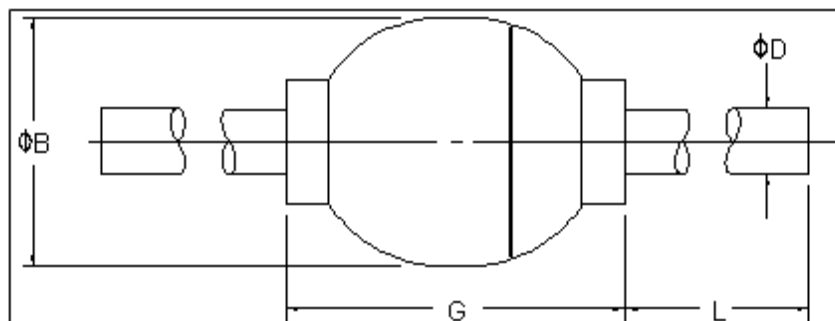


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PACKAGE DIMENSIONS (inches/mm)

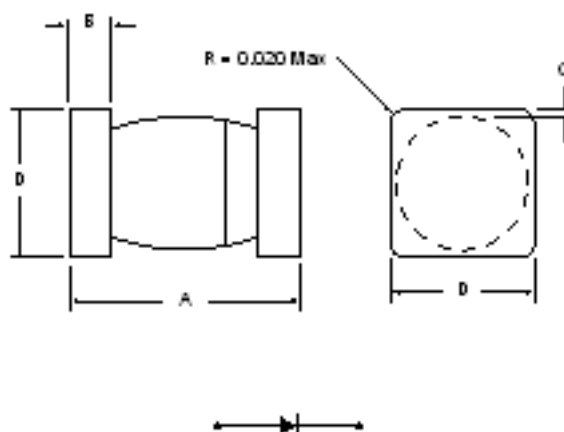
AXIAL



PACKAGE STYLE	DIMENSIONS - INCHES (MILLIMETERS)			
	ϕB	ϕD	G	L
304	.115/.142 2.92/3.61	.036/.042 .94/1.07	.130/.300 3.30/7.62	.90/1.30 22.9/33.0

MELF (Add "US" to Part Number)

MELF PACKAGE OUTLINES

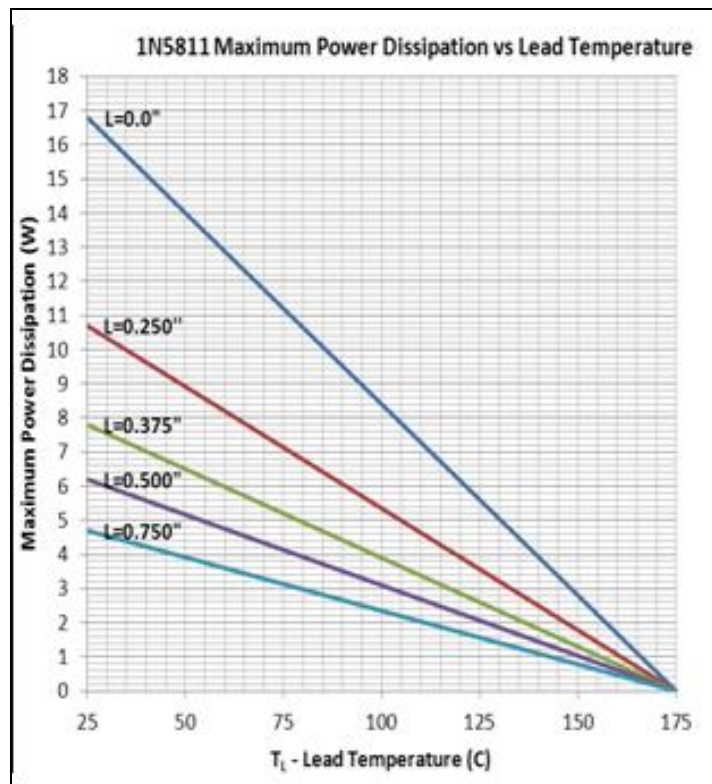
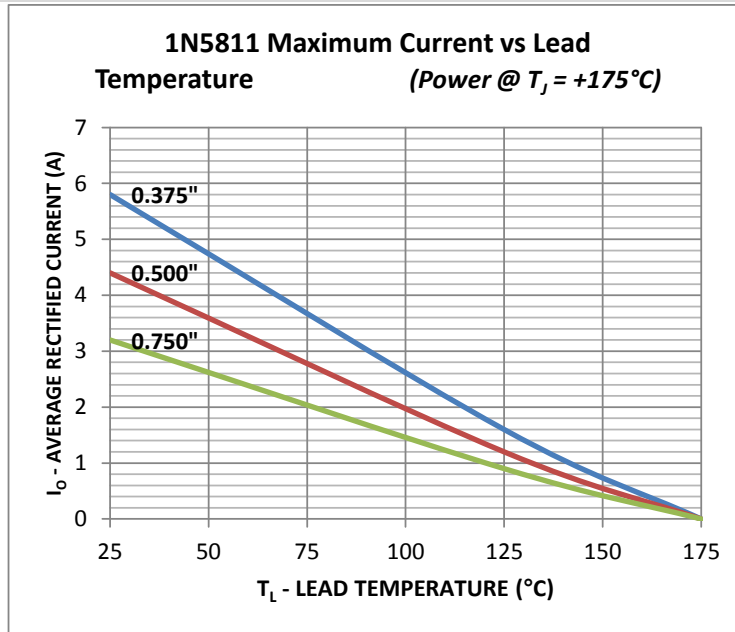


Note: Cathode side of device is indicated by a dark band marked on body.

PACKAGE STYLE	DIMENSIONS - INCHES / MILLIMETERS			
	A	B	C	D
MELF-B	.200/.225 5.0/5.8	0.019/.028 .48/.72	.003 Min .076 Min	.137/.148 3.4/3.8

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GRAPHS:



TECHNICAL DATA

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PART ORDERING INFORMATION

The following part numbers can be purchased in either axial or surface mount devices and screened and tested to the military screening flow. The parts are marked in accordance with the testing performed, example:

**Available with silver leads (SS5811-AG).*

Sensitron Screening Level	*Part Number-- Leaded Package (example for 1N5811)	*Part Number-- Surface Mount Package (example for 1N5811US)
1N	1N5811	1N5811US
JAN	JAN1N5811	JAN1N5811US
JANTX	JANTX1N5811	JANTX1N5811US,
JANTXV	JANTXV1N5811	JANTXV1N5811US
SJ	SJ5811	SJ5811US
SX	SX5811	SX5811US
SV	SV5811	SV5811US
JANS	JANS1N5811	JANS1N5811US
SS	SS5811	SS5811US

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